



THERMAL Management of Microelectronic Equipment

Heat Transfer Theory,
Analysis Methods,
and Design Practices

Lian-Tuu Yang and Richard C. Chu

ASME Press Book Series on Electronic Packaging
Dennis Mikolajewicz, Editor-in-Chief

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TK7870
.25
.Y44
2002

TK 7870.25

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Three Park Ave., New York, NY 10016

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Library of Congress Cataloging-in-Publication Data

Yeh, L.-T. (Lian-Tuu), 1944-

Thermal management of microelectronic equipment: heat transfer theory, analysis methods, and design practices / L.-T. Yeh and R. C. Chu.

p. cm.

ISBN 0-7918-0168-3

1. Electronic apparatus and appliances - Cooling. 2. Electronic apparatus and appliances - Thermal properties. 3. Heat - Transmission. I. Chu, R. C. (Richard C.), 1933. II. Title.

TK7870.25.Y44 2002
621.381'04 - dc21

2001034086

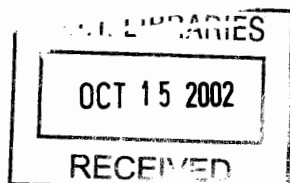


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